

ERP	Description	Location
101399-000130-00	0402-680Ω, 1/16W, ± 5%, SMD resistor	R45
101301-000173-00	0603-56Ω,SMT resistance	R73,R74,R76,R77
101301-000089-00	0603-510Ω,1/16W,±1%,SMT resistance	R7
101301-000208-00	0603-2.2kΩ,1/16W,±1%, SMT resistance	R23,R35
101302-000106-00	0805-1kΩ,1%, SMT resistance	R11
101302-000107-00	0805-2kΩ,1%, SMT resistance	R46
101302-000001-00	0805-18kΩ,SMT resistance	R3
101303-000116-00	1206-5.1kΩ,1/8W,±1%, SMT resistance	R17,R29
101401-000001-00	0603-0.01μF,X7R,50V,±10%,SMT capacitance	C1,C6,C14,C20,C29,C31,C37,C40
101402-000003-00	0805-0.1μF,X7R,50V,±10%, SMT capacitance	C10,C44
101402-000192-00	0805-2.2uF/50V, C2012Y5V1H225Z, chip capacitors	C23,C34
101499-000022-00	1210-1.0μF,X7R,100V,±10%,SMT capacitance	C46,C48,C50,C52
101499-000008-00	1210-1μF, Y5V, 50V, ± 20%, chip capacitors	C9,C43
101499-000025-00	10uF,50V,TDKC5750X7R1H106M, SMT capacitance	C8
101408-000032-00	E-type-22μF, Ta, 35V, ± 10%, SMD tantalum electrolytic capacitors	C41
101499-000004-00	47uF/50V,EEE-FK1H470XP, capacitance	C2,C5,C17,C30,C38
101408-000042-00	100μF,Ta,20V,±20%,SMT capacitance	C21,C22,C24,C32,C33,C35
101412-000003-00	EEE-FK1H221P400×400,220uF,50V capacitance	C42,C45
101499-000016-00	1206-0.1μF100CT4-1206B104K201F3 ceramic capacitors	C47,C49,C51,C53
101509-000003-00	MSS1278-473ML, inductance	L1,L2,L3,L4,L5,L6,L7,L8
101501-000044-00	PB451616L600Y6A0T,SMT magnetic bead	F1
101601-000010-00	30BQ040PBF,3A,40V, diode	D5,D14
101601-000143-00	MBRS540T3G, diode	D8,D11
101601-000154-00	VB30200C-E3/8W, D2PACK, Schottky diodes	D16
102003-000017-00	HE14,5×2 socket(0-0281739-5)	X34
102003-000149-00	LYVH-4A,socket	X1,X2
102309-000002-00	0.8mm, solder	
102309-000023-00	RMA-010-FPA,TAMURA solder	
101724-000425-00	RA-6200P-5001PC,FR4,PCB	